4208212-3/C 06/11

DSJ (R-PVSON-N14) PLASTIC SMALL OUTLINE NO-LEAD В PIN 1 INDEX AREA TOP AND BOTTOM 1,00 0,80 -0,20 REF. SEATING PLANE 0,08 0,05 0,00 C 14X $\frac{0,50}{0,30}$ THERMAL PAD SIZE AND SHAPE SHOWN ON SEPARATE SHEET 14 ♦ 0,10 M C A B 3,00

NOTES: A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M—1994.

- B. This drawing is subject to change without notice.
- C. Quad Flatpack, No-Leads (QFN) package configuration.
- D. The package thermal pad must be soldered to the board for thermal and mechanical performance.
- E. See the additional figure in the Product Data Sheet for details regarding the exposed thermal pad features and dimensions.



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